	2000 IEE U.S. DEPARTMENT OF COMMER	
(Rev. 6-93) OMB No. 0651-0011 (exp. 4/94)	Patent and Trademark Off	
Tab settings ⇒⇒⇒ To the Honorable Commission 102921	e record the attached original documents or copy thereof.	
Name of conveying party(ies):	Name and address of receiving party(ies):	
1. Harry Hedler	Name: Infineon Technologies AG	
Bernd Römer		
(Additional name(s) of conveying party(ies) attached) Yes ⊠No	Street Address: StMartin-Strasse 53	
	City: <u>Muenchen</u>	
Nature of conveyance: ☑ Assignment ☐ Merger	State: <u>Germany</u>	
☐ Security Agreement ☐ Change of Name ☐ Other	ZIP: <u>81669</u>	
Execution Date: January 31, 2002 for 1, February 5, 2002 for 2.	Additional name(s) & address(es) attached □Yes ⊠No	
4. Application number(s) or patent number(s):		
If this document is being filed together with a new appl		
A. Patent Application No.(s)	B. Patent No.(s) OPR/F s attached □ Yes ⊠No	
10/056,356		
Additional numbers	s attached ☐ Yes 図No	
5. Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involve	
Name: Lerner and Greenberg	7. Total fee (37 CFR 3.41)\$ 40.00	
Internal Address:	☑ Enclosed ☐ Authorized to be charged to deposit account	
Street Address: P.O. Box 2480		
City: Hollywood	8. Deposit account number:	
State: <u>FL</u>		
ZIP: <u>33022</u>	(Attach duplicate copy of this page by deposit account)	
DO NOT US	SE THIS SPACE	
 Statement and signature. To the best of my knowledge and belief, the tany attached copy is a true copy of the origin 	* *	
WERNER H. STEMER REG. NO. 34,956	January 7, 2005	
Name of Person Signing	Signature Date	
Total number of neese including as	over sheet, attachments, and document:	

PATENT REEL: 016147 FRAME: 0878 Dacket No.: MAS-FIN-128

ASSIGNMENT

WHEREAS we, HARRY HEDLER and BERND RÖMER, residing respectively at Regensburg and Bernhardswald, Germany, have invented certain new and useful improvements in an

ELECTRONIC COMPONENT WITH A SEMICONDUCTOR CHIP AND METHOD OF PRODUCING THE ELECTRONIC COMPONENT

for which an application for Letters Patent of the United States of America was executed on the date of execution of this assignment;

WHEREAS, INFINEON TECHNOLOGIES AG, a German corporation doing business at München, Germany, is desirous of acquiring the entire interest in said invention, and in any and all Letters Patent of the United States that may be obtained therefor;

NOW, THEREFORE, be it known that for and in consideration of my employment by the said corporation and other valuable consideration, the receipt and sufficiency whereof are hereby acknowledged, we have sold, assigned and transferred, and by these presents do sell, assign and transfer unto the said corporation, its legal representatives, successors and assigns, the full and exclusive right to the said invention as fully set forth and described in the above-mentioned application, and to said application and any and all divisions and continuations thereof, and any and all Letters Patent of the United States which may be granted therefor, and any and all reissues of said Letters Patent, the same to be held and enjoyed by the said corporation, its legal representatives, successors and assigns, to the full end of the term for which said Letters Patent may be granted or may be reissued or extended, as fully and entirely as the same would have been held by me had this assignment and sale not been made.

AND we hereby authorize the Commissioner of Patents to Issue any and all Letters Patent of the United States on said invention or resulting from said Application and from any and all divisions and continuations thereof to the said corporation as the assignee of the entire right, title and interest in and to the same.

IN TESTIMONY WHEREOF, we have hereunto set our hands and seals.

Minde presence pri	Larry Healer (LS)	Date: 31.01.02
	BERND RÖMER (LS)	Date:

Docket No.: MAS-FIN-128

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IN TESTIMONY WHEREOF, we have hereunto set our hands and seals.

In the presence of:

HARRY HEDLER

Date:

(LS)

(LS)

BERND ROMER

Date 05 Full 2002

PATENT

REEL: 016147 FRAME: 0880

RECORDED: 01/11/2005